查询TL7702BCDR供应商

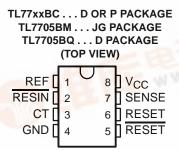
捷多邦,专业PCB打**样上7702B**,时**业有05**B, TL7733B SUPPLY-VOLTAGE SUPERVISORS

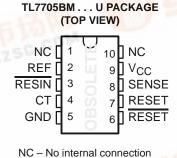
The TL7705BM is obsolete and no longer is supplied.

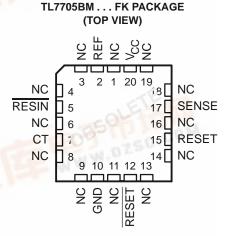
SLVS037M - SEPTEMBER 1989 - REVISED MAY 2003

- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- RESET Output Defined From V_{CC} ≥ 1 V
- Precision Voltage Sensor

- Temperature-Compensated Voltage Reference
- True and Complement Reset Outputs
- Externally Adjustable Pulse Duration







NC - No internal connection

description/ordering information

The TL7702B, TL7705B, and TL7733B are integrated-circuit supply-voltage supervisors designed for use as reset controllers in microcomputer and microprocessor systems. The supply-voltage supervisor monitors the supply for undervoltage conditions at the SENSE input. During power up, the RESET output becomes active (low) when V_{CC} attains a value approaching 1 V. As V_{CC} approaches 3 V (assuming that SENSE is above V_{T+}), the delay-timer function activates a time delay, after which outputs RESET and RESET go inactive (high and low, respectively). When an undervoltage condition occurs during normal operation, outputs RESET and RESET go active. To ensure that a complete reset occurs, the reset outputs remain active for a time delay after the voltage at the SENSE input exceeds the positive-going threshold value. The time delay is determined by the value of the external capacitor C_T : $t_d \approx 2.6 \times 10^4 \times C_T$, where C_T is in farads (F) and t_d is in seconds (s).

An external capacitor (typically 0.1 μ F) must be connected to REF to reduce the influence of fast transients in the supply voltage.

The TL7702BC, TL7705BC, and TL7733BC are characterized for operation from 0°C to 70°C. The TL7702BI, TL7705BI, and TL7733BI are characterized for operation from –40°C to 85°C. The TL7705BQ is characterized for operation from –40°C to 125°C. The TL7705BM is characterized for operation from –55°C to 125°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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description/ordering information (continued)

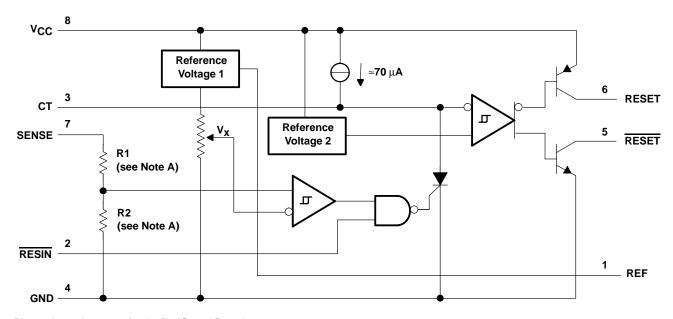
ORDERING INFORMATION

TA	PACKA	GE [†]	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP (P)	Tube of 50	TL7702BCP	TL7702BCP
	SOIC (D)	Tube of 75	TL7702BCD	7702BC
	30IC (D)	Reel of 2500	TL7702BCDR	7702BC
	PDIP (P)	Tube of 50	TL7705BCP	TL7705BCP
0°C to 70°C	SOIC (D)	Tube of 75	TL7705BCD	7705BC
	30IC (D)	Reel of 2500	TL7705BCDR	7705BC
	PDIP (P)	Tube of 50	TL7733BCP	TL7733BCP
	SOIC (D)	Tube of 75	TL7733BCD	7733BC
	3010 (D)	Reel of 2500	TL7733BCDR	773360
	PDIP (P)	Tube of 50	TL7702BIP	TL7702BIP
	SOIC (D)	Tube of 75	TL7702BID	7702BI
	30IC (D)	Reel of 2500	TL7702BIDR	770261
	PDIP (P)	Tube of 50	TL7705BIP	TL7705BIP
–40°C to 85°C	SOIC (D)	Tube of 75	TL7705BID	7705BI
	301C (D)	Reel of 2500	TL7705BIDR	770361
	PDIP (P)	Tube of 50	TL7733BIP	TL7705BIP
	SOIC (D)	Tube of 75	TL7733BID	7733BI
	3010 (D)	Reel of 2500	TL7733BIDR	I I SSDI
-40°C to 125°C	SOIC (D)	Tube of 75	TL7705BQD	TL7705BQD

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

functional block diagram

The functional block diagram is shown for illustrative purposes only; the actual circuit includes a trimming network to adjust the reference voltage and sense-comparator trip point.



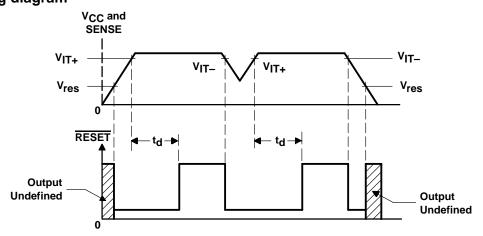
Pin numbers shown are for the D, JG, and P packages.

NOTE A: TL7702B: R1 = 0 Ω , R2 = open, $V_X = V_{REF1}$

TL7705B: R1 = 23 k Ω , R2 = 10 k Ω , nominal, $V_X \approx 1.43$ V

TL7733B: R1 = 11.3 k Ω , R2 = 10 k Ω , nominal, $V_X \approx 1.43$ V

typical timing diagram



TL7702B, TL7705B, TL7733B SUPPLY-VOLTAGE SUPERVISORS

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The TL7705BM is obsolete and no longer is supplied.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	20 V
Input voltage range, V _I : RESIN	
SENSE	0.3 V to 20 V
High-level output current, IOH (RESET)	–30 mA
Low-level output current, IOL (RESET)	30 mA
Package thermal impedance, θ _{JA} (see Notes 2 and 3):D package	97°C/W
P package	85°C/W
Operating virtual junction temperature, T _J	150°C
Case temperature for 60 seconds, T _C : FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: JG or U packages	300°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or P packages	260°C
Storage temperature range, T _{stq}	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to the network ground terminal.
 - 2. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

			MIN	MAX	UNIT
Vcc	Supply voltage		3.6	18	V
VIH	High-level input voltage	RESIN	2	18	V
V _{IL}	Low-level input voltage	RESIN	0	0.8	V
٧ _I	Input voltage	SENSE	0	18	V
ІОН	High-level output current	RESET		-20	mA
loL	Low-level output current	RESET		20	mA
	Operating free-air temperature range	TL77xxBC	0	70	
_		TL77xxBI	-40	85	°C
TA		TL7705BQ	-40	125	C
		TL7705BM	-55	125	

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electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER			TEST CONDITIONS [†]		TL77xxBC TL77xxBI TL7705BQ			UNIT		
						MIN	TYP	MAX		
Vон	High-level output vo	oltage, RES	ET	I _{OH} = -16 mA		V _{CC} -1.5			V	
VOL	Low-level output vo	Itage, RES	ET	I _{OL} = 16 mA				0.4	V	
V _{ref}	Reference voltage,	REF		$I_{ref} = -500 \mu A$,	T _A = 25°C	2.48	2.53	2.58	V	
			TL7702B			2.505	2.53	2.555		
			TL7705B	T _A = 25°C		4.5	4.55	4.6		
\ \ _V	Negative-going		TL7733B		3.03	3.08	3.13	,		
VIT-	V _{IT} input threshold volta at SENSE input	age	TL7702B			2.48	2.53	2.58	V	
			TL7705B	T _A = full range [‡]		4.45	4.55	4.65		
			TL7733B			3	3.08	3.16		
			TL7702B	V _{CC} = 3.6 V to 18 V, T _A			10			
V _{hys}	Hysteresis, SENSE (V _{IT+} - V _{IT-})		TL7705B		$T_A = 25^{\circ}C$		30		mV	
'	(VII+ - VII-)	v + - v -)		1			10			
V _{res} §	Power-up reset volt	age		I _{OL} at RESET = 2 mA,	T _A = 25°C			1	V	
	land to a company	RESIN		$V_I = 0.4 \text{ V to V}_{CC}$				-10		
'1	Input current SENSI	SENSE	TL7702B	V _I = V _{ref} to 18 V			-0.1	-2	μΑ	
ЮН	High-level output current, RESET		V _O = 18 V,	See Figure 1			50	μΑ		
lOL	OL Low-level output current, RESET		$V_{O} = 0 V$,	See Figure 1			-50	μΑ		
la a	Cumply ourrent			V _{SENSE} = 15 V,	RESIN ≥ 2 V		1.8	3	m A	
lcc	Supply current			V _{CC} = 18 V,	$T_A = \text{full range}^{\ddagger}$			3.5	mA	

switching characteristics, $V_{CC} = 5 \text{ V}$, C_T open, $T_A = 25^{\circ}C$

PARAMETER		PARAMETER FROM (INPUT) ((TL77xxBC TL77xxBI TEST CONDITIONS TL7705BQ		l	UNIT		
					MIN	TYP	MAX		
tPLH	Propagation delay time from low- to high-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500	ns	
tPHL	Propagation delay time from high- to low-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500	ns	
	Effective pulse duration	RESIN		See Figure 2		150		200	
t _W	Effective pulse duration	SENSE		See Figure 2		100		ns	
t _r	Rise time	9 9 France 4 46	See Figures 1 and 3			75	20		
t _f	Fall time		RESET	See rigules 1 and 3		150	200	ns	
t _r	Rise time		RESET	Soo Figures 1 and 2		75	150		
t _f	Fall time		KESEI	See Figures 1 and 3			50	ns	

[†] All electrical characteristics are measured with 0.1-μF capacitors connected at REF, CT, and V_{CC} to GND. ‡ Full range is 0°C to 70°C for the C-suffix devices, –40°C to 85°C for the I-suffix devices, and –40°C to 125°C for the Q-suffix device. § This is the lowest voltage at which RESET becomes active.

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electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER			TEST CONDITIONS		TL7705BM				
	TAKAWETEK			lesi coi	TEST CONDITIONST		TYP	MAX	UNIT
Vон	High-level outpu	ut voltage, F	RESET	I _{OH} = -16 mA		V _{CC} -1.5			V
VOL	Low-level outpu	t voltage, R	ESET	I _{OL} = 16 mA				0.4	V
V _{ref}	Reference volta	ge, REF		$I_{ref} = -500 \mu A$,	T _A = 25°C	2.48	2.53	2.58	V
			TL7702B	T 25°C		2.505	2.53	2.555	
\ \/	Negative-going V _{IT} input threshold at SENSE input		TL7705B	T _A = 25°C	4.5	4.55	4.6	,	
VIT-		SENSE input TL7702E	TL7702B	T _A = -55°C to 125°C	2.48	2.53	2.58		
	·		TL7705B			4.45	4.55	4.65	
\/.	V _{hys} Hysteresis, SENSE (V _{IT+} - V _{IT-})		TL7702B	V _{CC} = 3.6 V to 18 V, T _A = 25°C		10		mV	
vhys			TL7705B			30		1117	
v _{res} ‡	Power-up reset	voltage		I_{OL} at $\overline{RESET} = 2 \text{ mA}$,	T _A = 25°C			1	V
Ţ.,	langut ourroat	RESIN		$V_I = 0.4 \text{ V to V}_{CC}$				-10	
l _l	Input current SEI	SENSE	TL7702B	$V_I = V_{ref}$ to $V_{CC} - 1.5$	V		-0.1	-2	μΑ
IOH High-level output current, RESET		V _O = 18 V				50	μΑ		
loL	IOL Low-level output current, RESET		V _O = 0				-50	μΑ	
loo	Supply current	•		VSENSE = 15 V,	RESIN ≥ 2 V		1.8	3	mΔ
Icc	Supply current		V _{CC} = 18 V,	$T_A = -55^{\circ}C$ to $125^{\circ}C$			4	mA	

[†] All electrical characteristics are measured with 0.1-μF capacitors connected at REF, CT, and V_{CC} to GND. ‡ This is the lowest value at which RESET becomes active.

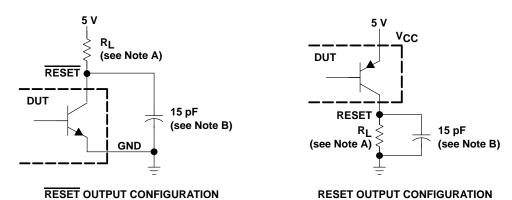
switching characteristics, V_{CC} = 5 V, C_T open, T_A = 25°C

	PARAMETER	FROM	то	TEST CONDITIONS	TL7705BM			UNIT	
	PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
tPLH	Propagation delay time from low- to high-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500*	ns	
tPHL	Propagation delay time from high- to low-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500*	ns	
	Effective pulse duration	RESIN		See Figure 2		150			
t _W	Effective pulse duration	SENSE		See Figure 2		100		ns	
t _r	Rise time		DECET	See Figures 1 and 3			75*	ns	
t _f	Fall time		RESET	See Figures 1 and 3		150	200*	113	
t _r	Rise time		RESET	See Figures 1 and 3		75	150*	ns	
t _f	Fall time		RESET	See Figures 1 and 5			50*	115	

^{*} On products compliant to MIL-PRF-38535, these parameters are not production tested.



PARAMETER MEASUREMENT INFORMATION



NOTES: A. For I $_{OL}$ and I $_{OH}$, R $_{L}$ = 10 k Ω . For all switching characteristics, R $_{L}$ = 511 Ω .

B. This figure includes jig and probe capacitance.

Figure 1. RESET and RESET Output Configurations



Figure 2. Input Pulse Definition

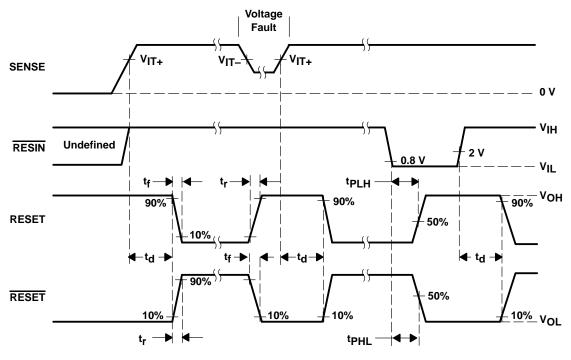
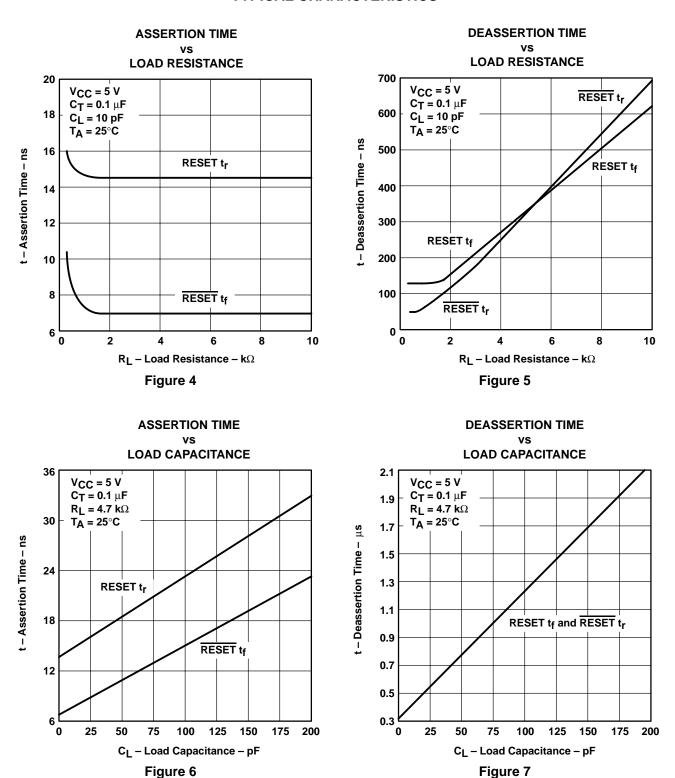


Figure 3. Voltage Waveforms



TYPICAL CHARACTERISTICS[†]



[†] For proper operation, both RESET and RESET should be terminated with resistors of similar value. Failure to do so may cause unwanted plateauing in either output waveform during switching.



APPLICATION INFORMATION

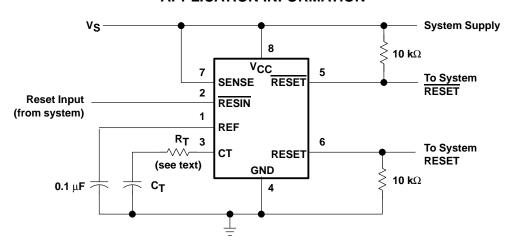


Figure 8. System Reset Controller With Undervoltage Sensing

When the TL770xB SENSE terminal is used to monitor V_{CC}, a current-limiting resistor in series with C_T is recommended. During normal operation, the timing capacitor is charged by the onboard current source to approximately V_{CC} or an internal voltage clamp (≈7.1-V Zener), whichever is less. When the circuit then is subjected to an undervoltage condition during which V_{CC} is rapidly slewed down, the voltage on CT exceeds that on V_{CC}. This forward biases a secondary path internally, which falsely activates the outputs. A fault is indicated when V_{CC} drops below V_(CT), not when V_{SENSE} falls below V_T.

Texas Instruments performs a 100% electrical screen to verify that the outputs do not switch with 1 mA forced into the CT terminal. Adding the external resistor, R_T, prevents false triggering. Its value is calculated as follows:

$$\frac{V_{(CT)}-V_{T_{-}}}{R_{\tau}}$$

Where:

 $V_{(CT)} = V_{CC}$ or 7.1 V, whichever is less $V_{T-} = 4.55$ V (nom)

= value of series resistor required

For $V_{CC} = 5 \text{ V}$:

$$\frac{5 \, - \, 4.55}{R_{\scriptscriptstyle T}} \; < \; 1 \; \, \text{mA}$$

Therefore,

$$R_{\scriptscriptstyle T}$$
 > 450 Ω

Using a 20%-tolerance resistor, R_T should be greater than 560 Ω .

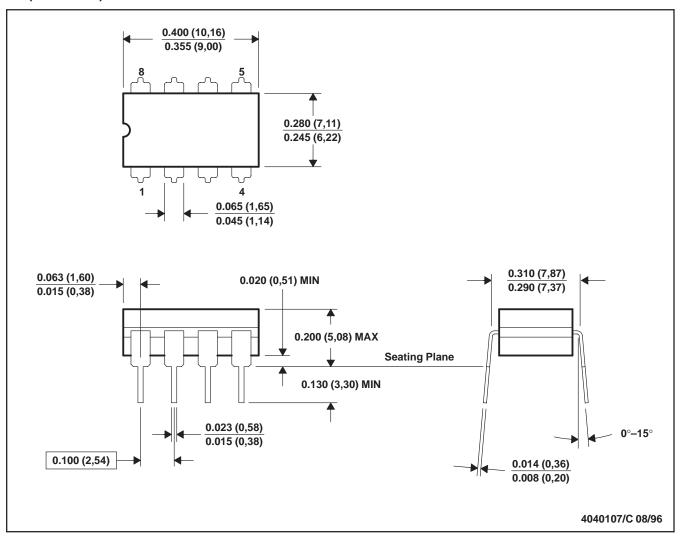
Adding this series resistor changes the duration of the reset pulse by no more than 10%. RT extends the discharge of C_T , but also skews the $V_{(CT)}$ threshold. These effects tend to cancel one another. The precise percentage change can be derived theoretically, but the equation is complicated by this interaction and is dependent upon the duration of the supply-voltage fault condition.

Both outputs of the TL770xB should be terminated with similar value resistors, even when only one is being used. This prevents unwanted plateauing in either output waveform during switching, which may be interpreted as an undefined state or delay system reset.



JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE



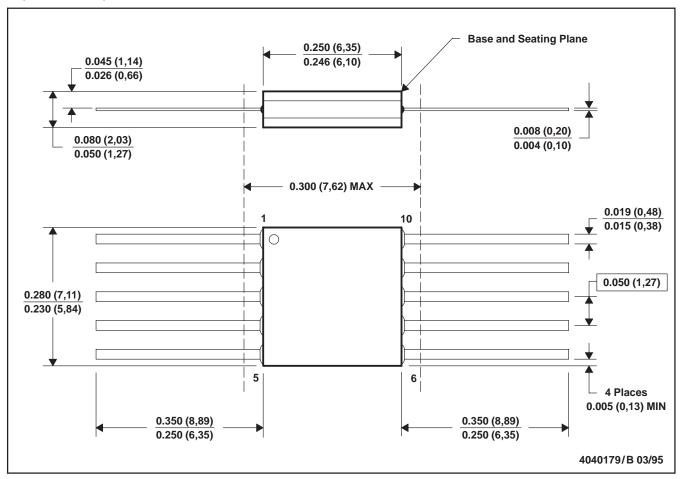
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8



U (S-GDFP-F10)

CERAMIC DUAL FLATPACK



NOTES: A. All linear dimensions are in inches (millimeters).

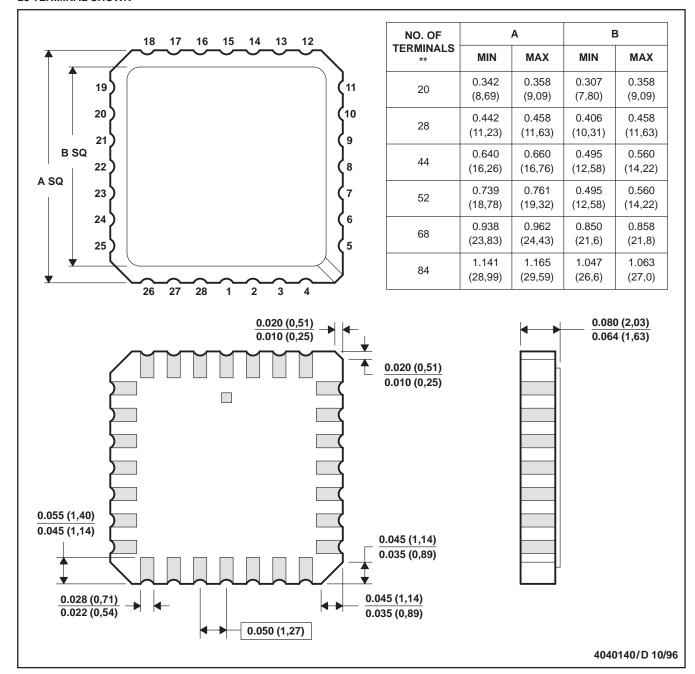
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F10 and JEDEC MO-092AA



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER

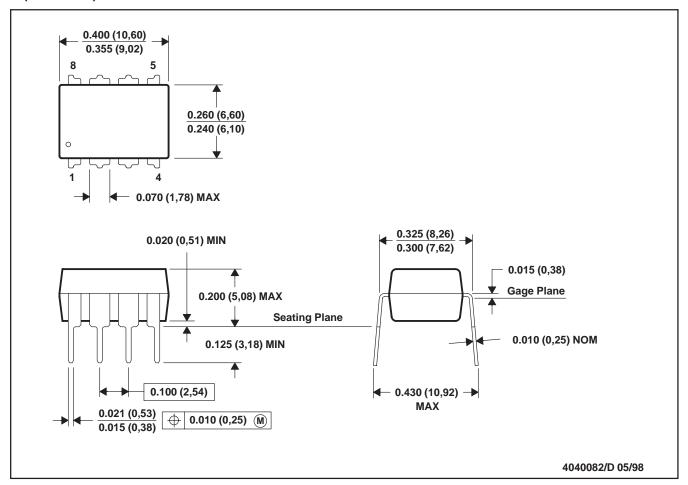


- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a metal lid.
 - D. The terminals are gold plated.
 - E. Falls within JEDEC MS-004



P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



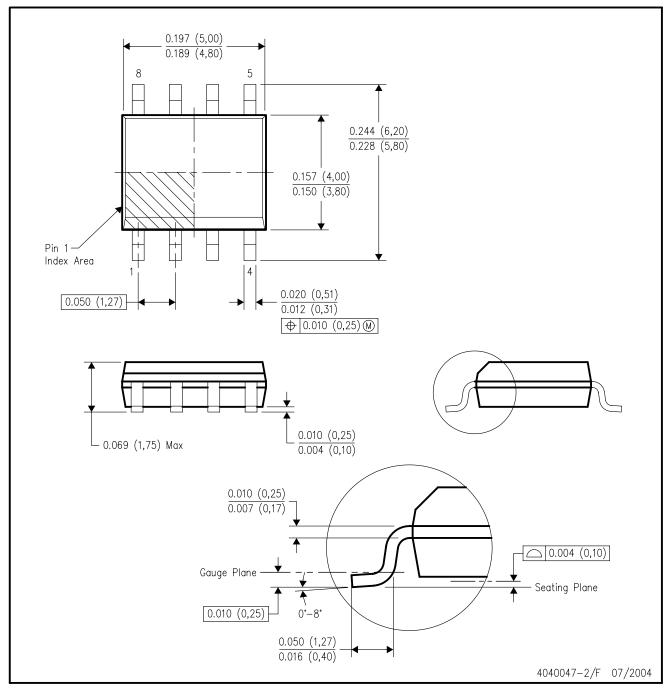
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AA.



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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265